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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: George Hsieh
Title: USING THE WAVE SOLDERING PROCESS TO ATTACH MOTHERBOARD CHIPSET HEAT SINKS
Docket No.: 884.462US1
Filed: June 29, 2001
Examiner: Unknown
Serial No.: 09/897,320
Due Date: N/A
Group Art Unit: 2835

Commissioner for Patents
Washington, D.C. 20231

We are transmitting herewith the following attached items (as indicated with an "X"):

- ☒ A return postcard.
- ☒ An Information Disclosure Statement (1pgs.), Form 1449 (1 pgs.), and copies of 2 cited references.

Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional required fees or credit overpayment to Deposit Account No. 19-0743.

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By: Ann M. McCrackin
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Reg. No. 42,858

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on this 14 day of February, 2002.

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